	ND BONDING COI or use of this form, se				
1. FACILITY			2. DATE (YYYYMMDD)		
3. LOCATION			4. INSPECTOR		
5. GENERAL CONDITION					
EXCELLENT	GOOD	POOR	UNACCEPTABLE		
6. SPECIFIC DEFICIENCIES					
LOCATION	DEFICIENCIES				
7. RESISTANCE (Use double balanced 1.0 milli-ohm)	dc bridge or approved	l bond resistance met	er and identify those	bonds whose resistance is greater than	
LOCATION	DEFICIENCIES				
8. INEFFECTIVE BONDING JUMPERS					
LOCATION	MATERIAL	LENGTH	SIZE	DEFICIENCIES	